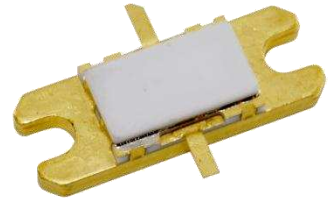


FEATURES

- High Voltage Operation : $V_{DS}=50V$
- High Power : 48.8dBm (typ.) @ P_{sat}
- High Efficiency: 60%(typ.) @ P_{sat}
- Power Gain : 16.5dB(typ.) @ $f=2.6GHz$
- Proven Reliability



DESCRIPTION

SEDI's GaN-HEMT offers high efficiency, ease of matching, greater consistency and broad bandwidth for high power L-band amplifiers with 50V operation, and gives you higher gain.

This new product is ideally suited for use in 2.6GHz WiMAX & LTE design requirements as it offers high gain, long term reliability and ease of use.

ABSOLUTE MAXIMUM RATINGS (Case Temperature $T_c=25deg.C$)

Item	Symbol	Condition	Rating	Unit
Operating-Voltage	V_{DS}		55	V
Drain-Source Voltage	V_{DS}	$V_{GS}=-8V$	160	V
Gate-Source Voltage	V_{GS}		-15	V
Total Power Dissipation	P_t		75	W
Storage Temperature	T_{stg}		-65 to +175	deg.C
Channel Temperature	T_{ch}		250	deg.C

RECOMMENDED OPERATING CONDITION

Item	Symbol	Condition	Limit	Unit
DC Input Voltage	V_{DS}		≤ 55	V
Forward Gate Current	I_{GF}	$R_G=5\text{ ohm}$	≤ 76	mA
Reverse Gate Current	I_{GR}	$R_G=5\text{ ohm}$	≥ -2.6	mA
Channel Temperature	T_{ch}		≤ 180	deg.C
Average Output Power	$P_{ave.}$		≤ 45.8	dBm

ELECTRICAL CHARACTERISTICS (Case Temperature $T_c=25deg.C$)

Item	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Pinch-Off Voltage	V_p	$V_{DS}=50V\ I_{DS}=18mA$	-1.0	-1.5	-2.0	V
Saturated Power	$P_{sat} *1$	$V_{DS}=50V$	48.0	48.8	-	dBm
Drain Efficiency	$\eta_d *2$	$I_{DS}(DC)=300mA$	25	30	-	%
Power Gain	$G_p *2$	$f=2.60GHz$	15.5	16.5	-	dB
Thermal Resistance	R_{th}	Channel to Case at 48W P_{DC}	-	2.5	3.0	deg.C/W

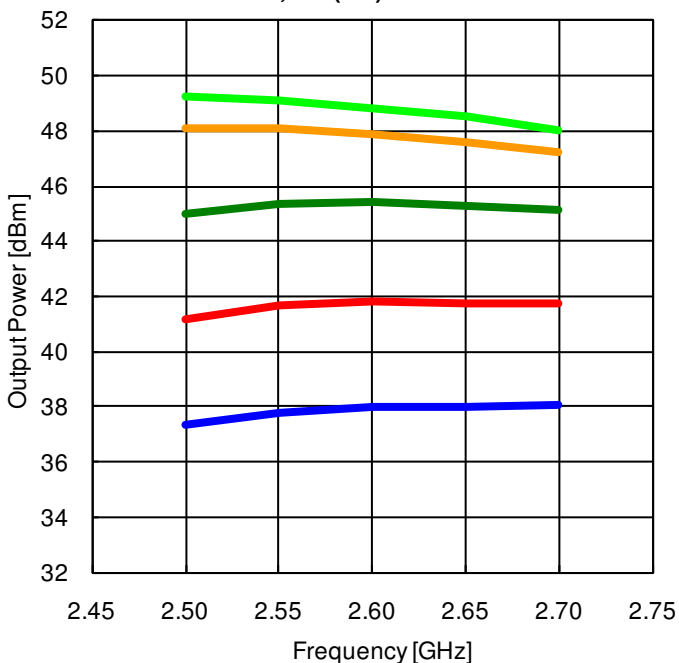
*1 : 10%-duty RF pulse (DC supply constant)

*2 : $P_{out} = 40.8dBm$, CW modulation Signal (W-CDMA)

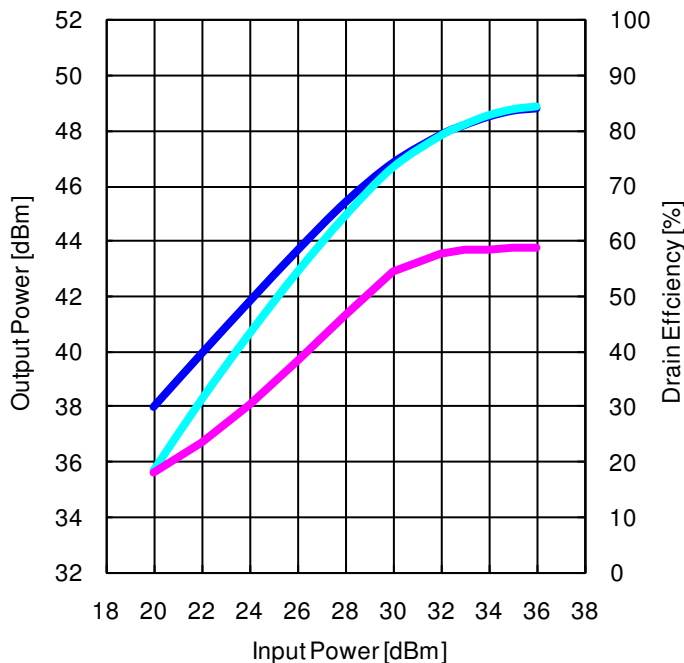
RoHS COMPLIANCE	Yes
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RF characteristics @f=2.6GHz fine tuned

Output Power vs. Frequency
VDS=50V, IDS(DC)=300mA



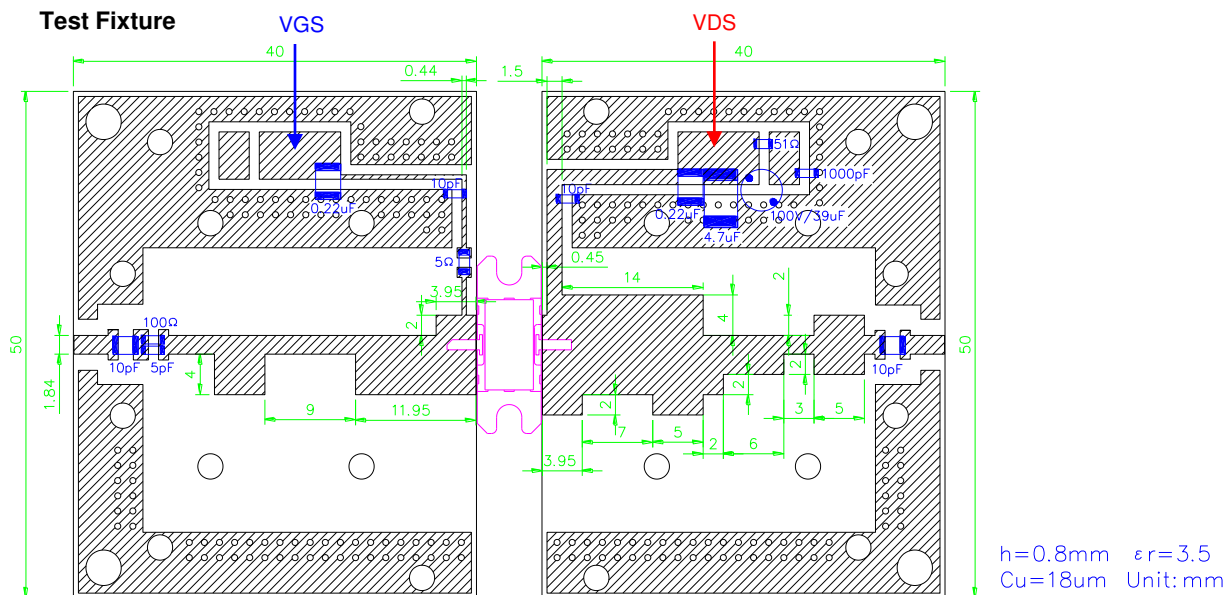
Output Power and Drain Efficiency vs. Input Power
VDS=50V, IDS(DC)=300mA, f=2.6GHz

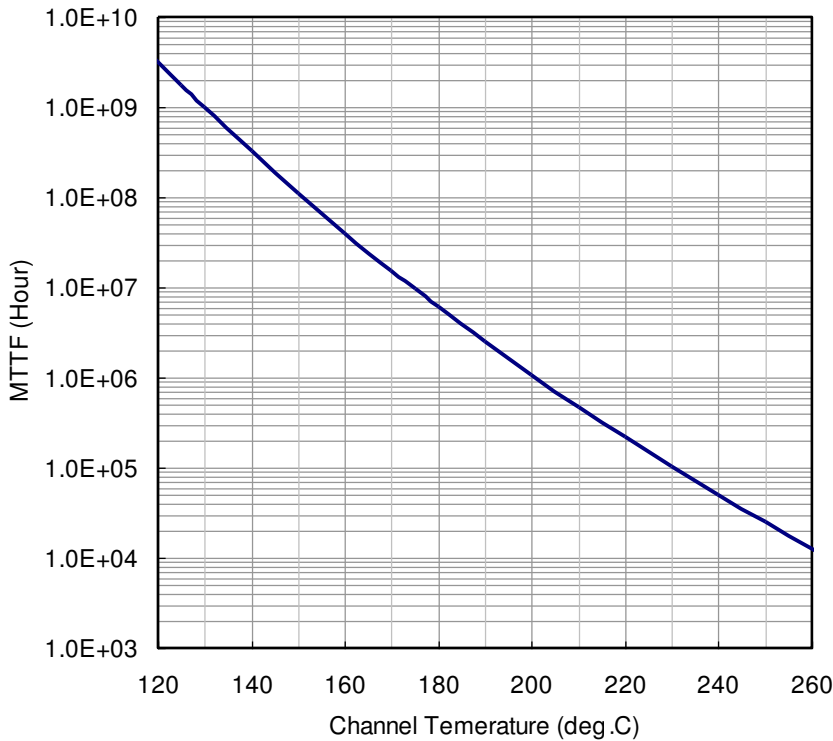


— Pin=20dBm — Pin=24dBm — Pin=28dBm
— Pin=32dBm — Pin=36dBm

— Pout (class AB) — Pout (class B) — Nd (class B)

Pulse Signal (10%-duty, DC : constant)





Ea=1.6eV
Confidence Level=90%

Channel Temp (deg.C)	MTTF (Hours)
160	4.05 x 10 ⁷
180	6.07 x 10 ⁶
200	1.07 x 10 ⁶

$$AF = \exp\left[-\frac{Ea}{k}\left(\frac{1}{T_{stress}} - \frac{1}{T_{use}}\right)\right]$$

$$MTTF_{use} = MTTF_{stress} * AF$$

Where;

AF: acceleration factor

Ea: activation energy (1.6 eV)

k: Boltzman's constant (8.62×10^{-5} eV/K)

T_{stress}: stress temperature (K)

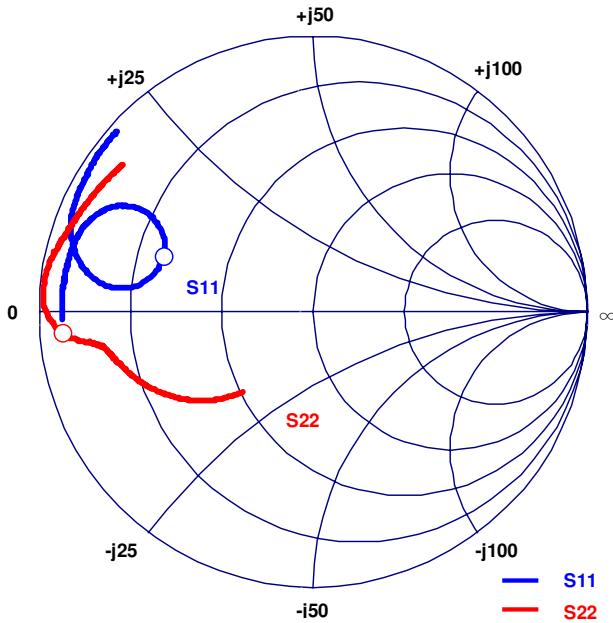
T_{use}: use temperature (K)

ESD characteristic

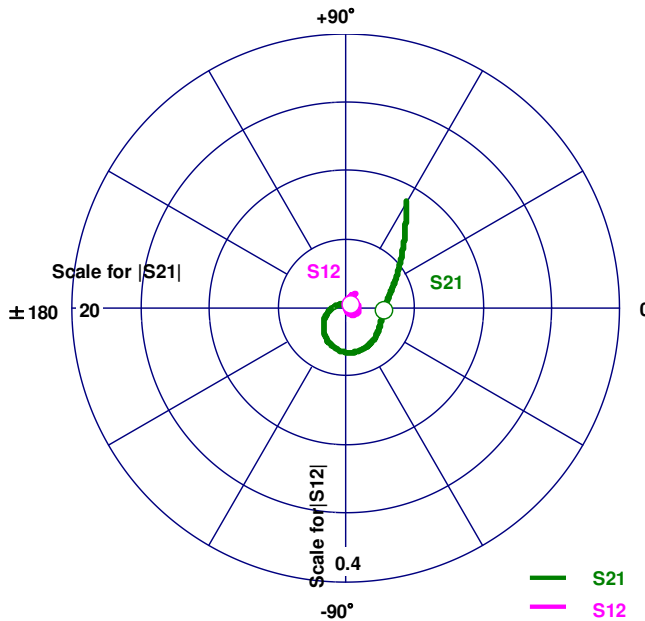
Test Methodology	Class
Human Body Model (per JESD22-A114)	0
Machine Model (per JEIA/ESD22-A115)	A

S-Parameters @VDS=50V, IDS(DC)=300mA, f=0.5 to 4.5GHz

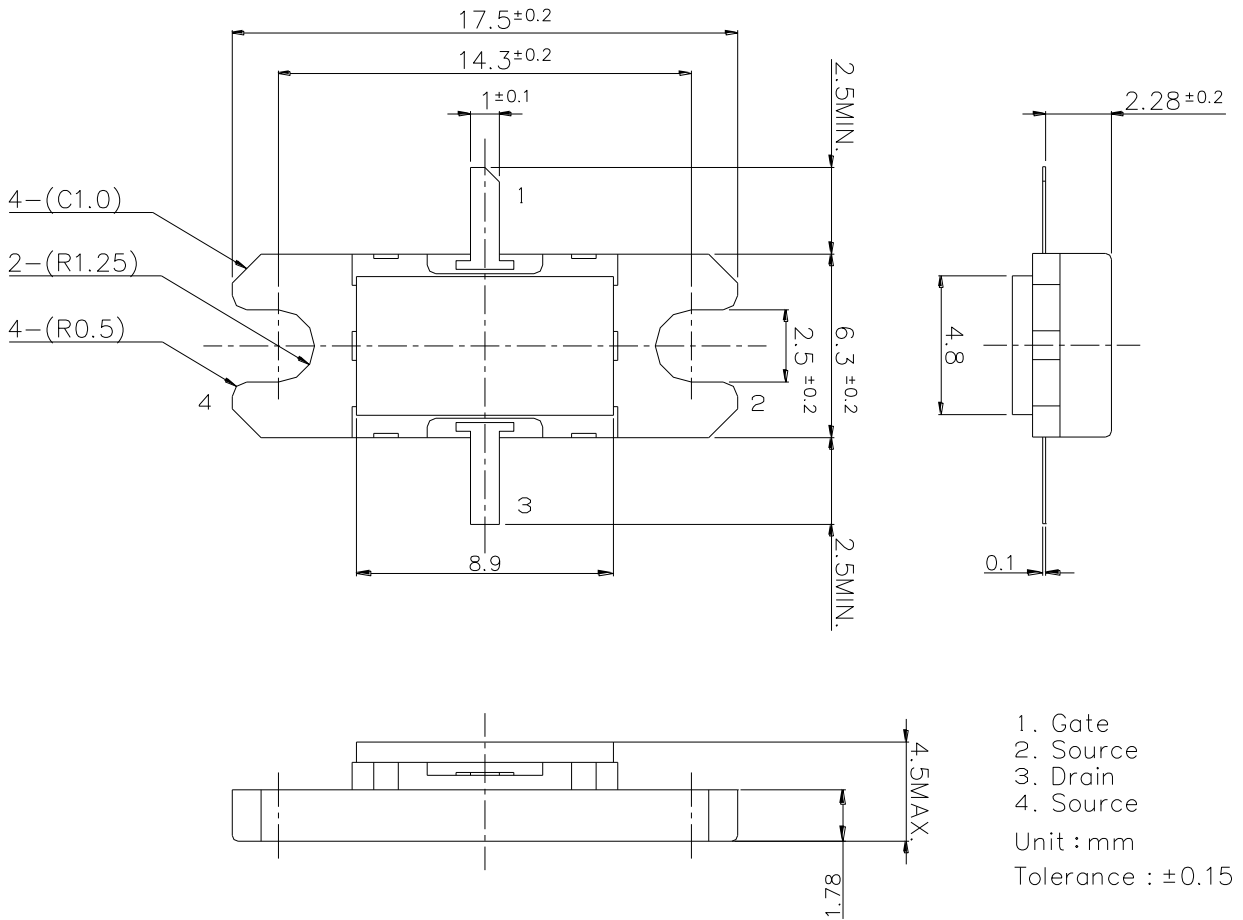
ZI = Zs = 50 ohm Marker : 2.6GHz



Freq. GHz	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
0.50	0.92	-178.40	8.90	60.55	0.007	-1.89	0.39	-131.35
0.60	0.92	178.91	7.33	53.84	0.006	1.13	0.43	-134.83
0.70	0.92	176.67	6.21	47.58	0.006	5.64	0.48	-138.15
0.80	0.92	174.65	5.35	41.77	0.006	7.79	0.52	-141.44
0.90	0.92	172.67	4.71	35.85	0.006	9.09	0.55	-144.66
1.00	0.92	170.91	4.21	30.71	0.006	13.06	0.58	-147.73
1.10	0.91	169.14	3.83	25.36	0.006	17.19	0.61	-150.65
1.20	0.91	167.54	3.51	20.24	0.006	21.31	0.64	-153.20
1.30	0.91	165.85	3.25	15.36	0.006	28.76	0.66	-156.17
1.40	0.91	164.25	3.06	10.37	0.007	31.03	0.68	-158.52
1.50	0.91	162.78	2.91	5.75	0.007	33.02	0.70	-160.81
1.60	0.90	161.09	2.80	0.83	0.008	34.69	0.72	-163.00
1.70	0.89	159.45	2.72	-4.20	0.009	34.03	0.73	-165.03
1.80	0.88	157.86	2.68	-9.94	0.010	33.49	0.75	-166.83
1.90	0.87	156.17	2.69	-15.15	0.011	32.21	0.76	-168.34
2.00	0.85	154.31	2.71	-21.13	0.012	29.94	0.77	-169.56
2.10	0.82	152.35	2.79	-28.14	0.013	26.27	0.78	-170.50
2.20	0.79	150.71	2.90	-36.53	0.014	21.44	0.79	-171.44
2.30	0.74	149.57	3.03	-45.73	0.016	14.39	0.81	-172.00
2.40	0.69	149.63	3.18	-57.25	0.017	6.35	0.84	-172.43
2.50	0.62	152.47	3.30	-71.13	0.019	-3.74	0.87	-173.18
2.60	0.58	159.82	3.30	-87.49	0.018	-19.49	0.92	-175.09
2.70	0.61	168.39	3.11	-104.72	0.017	-34.57	0.96	-178.20
2.80	0.68	172.72	2.76	-121.17	0.014	-49.84	0.98	178.42
2.90	0.76	172.81	2.34	-135.44	0.011	-62.90	0.99	174.86
3.00	0.83	170.57	1.96	-147.17	0.008	-72.62	0.98	171.84
3.10	0.87	168.01	1.64	-156.90	0.005	-84.83	0.98	169.07
3.20	0.90	165.37	1.38	-164.71	0.003	-94.32	0.97	167.12
3.30	0.92	162.74	1.17	-171.58	0.001	-123.85	0.96	165.02
3.40	0.94	160.43	1.01	-177.18	0.001	133.93	0.95	163.21
3.50	0.95	158.21	0.88	177.53	0.003	111.92	0.94	161.35
3.60	0.96	156.00	0.78	172.72	0.005	99.21	0.94	159.89
3.70	0.96	153.90	0.69	167.92	0.006	95.72	0.93	157.88
3.80	0.96	151.87	0.63	163.43	0.009	87.74	0.92	156.27
3.90	0.96	149.93	0.57	159.60	0.011	82.68	0.92	154.47
4.00	0.97	148.01	0.52	155.53	0.012	77.58	0.91	152.67
4.10	0.97	145.98	0.48	151.34	0.015	73.01	0.90	150.81
4.20	0.97	144.00	0.45	147.40	0.016	68.92	0.90	148.86
4.30	0.97	141.99	0.43	143.39	0.019	64.93	0.89	146.81
4.40	0.97	140.03	0.41	139.23	0.021	61.09	0.88	144.61
4.50	0.97	137.63	0.39	134.88	0.024	57.12	0.88	142.26



MK Package Outline Metal-Ceramic Hermetic Package





EGN26C070MK

High Voltage - High Power GaN-HEMT

For further information please contact:

<http://global-sei.com/Electro-optic/about/office.html>